XP06212 (XP6212)

Silicon NPN epitaxial planer transistor

For switching/digital circuits

Features

- Two elements incorporated into one package. (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

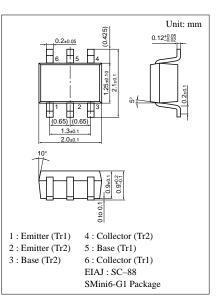
Basic Part Number of Element

• UNR1212(UN1212) \times 2 elements

Parameter		Symbol	Ratings	Unit
Rating of element	Collector to base voltage	V _{CBO}	50	V
	Collector to emitter voltage	V _{CEO}	50	V
	Collector current	I _C	100	mA
Overall	Total power dissipation	P _T	150	mW
	Junction temperature	Tj	150	°C
	Storage temperature	T _{stg}	-55 to +150	°C

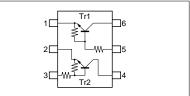
Absolute Maximum Ratings (Ta=25°C)

Electrical Characteristics (Ta=25°C)



Marking Symbol: 8V

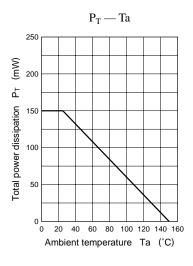
Internal Connection

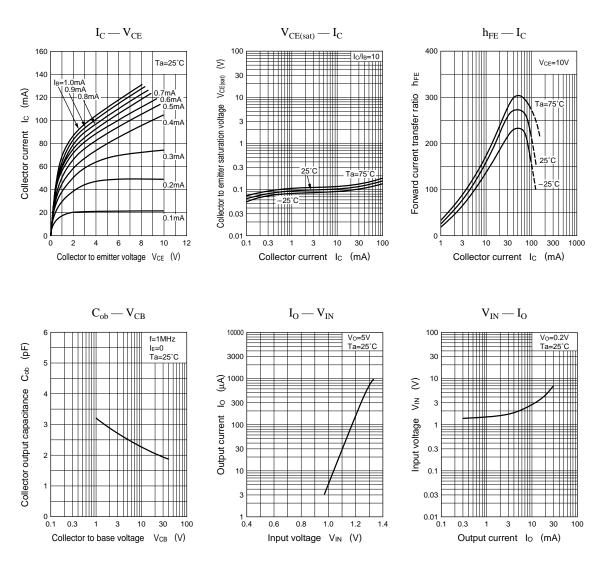


Parameter Symbol Conditions max Unit min typ Collector to base voltage V_{CBO} $I_{C} = 10 \mu A, I_{E} = 0$ 50 V V V_{CEO} $I_{C} = 2mA, I_{B} = 0$ 50 Collector to emitter voltage $V_{CB} = 50V, I_E = 0$ 0.1 μA I_{CBO} Collector cutoff current $V_{CE} = 50V, I_B = 0$ 0.5 I_{CEO} μΑ Emitter cutoff current I_{EBO} $V_{EB} = 6V, I_C = 0$ 0.2 mA Forward current transfer ratio $V_{CE} = 10V, I_C = 5mA$ 60 h_{FE} $V_{CE} = 10V, I_C = 5mA$ 0.99 hFE (small/large)*1 0.5 Forward current transfer h_{FE} ratio Collector to emitter saturation voltage $I_{C} = 10mA, I_{B} = 0.3mA$ 0.25 V V_{CE(sat)} Output voltage high level $V_{CC} = 5V, V_B = 0.5V, R_L = 1k\Omega$ 4.9 V V_{OH} $V_{CC} = 5V, V_B = 2.5V, R_L = 1k\Omega$ V Output voltage low level VOL 0.2 Transition frequency \mathbf{f}_{T} $V_{CB} = 10V, I_E = -2mA, f = 200MHz$ 150 MHz Input resistance R_1 -30% 22 +30% kΩ Resistance ratio 0.8 1.0 1.2 R_{1}/R_{2}

*1 Ratio between 2 elements

Note) The Part number in the Parenthesis shows conventional part number.





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